

## N-Channel MOSFET 650V, 7A,RDS(ON)<1.4

### Features:

- Superior Avalanche Rugged Technology
- Robust Gate Oxide Technology
- Excellent Switching Characteristics
- Low Gate Charge
- Extended Safe Operating Area
- Lower RDS(ON): 1.13 Ω (Typical) @ VGS = 10V
- 100% Avalanche Tested
- Improved dv/dt Capability
- RoHS Compliant
- JEDEC Qualification



### ABSOLUTE MAXIMUM RATINGS (Ta=25 °C)

Symbol	Parameter		Value	Unit
$BV_{DSS}$	Drain-Source Voltage		650	V
$BV_{GSS}$	Gate-Source Voltage		$\pm 30$	V
$I_D$	Drain Current continuous $T_c=25^\circ\text{C}$		7	A
$I_{DM}$	Drain Current - pulse		28	A
$P_D$	Power Dissipation	$T_c=25^\circ\text{C}$	57	W
		Derated above 25 °C	0.37	W/°C
$T_J, T_{STG}$	Operating and Storage Temperature Range		-55 ~ +150	°C
$T_L$	Maximum Lead Temperature for Soldering		260	°C

### Thermal Characteristics

Symbol	Parameter		TO-220F	Unit
$R_{\theta JC}$	Thermal Resistance ,Junction to Case		2.55	°C/W
$R_{\theta JA}$	Thermal Resistance ,Junction to Ambient		62.5	°C/W

### Electrical Characteristics(Tc=25°C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
<b>Off state characteristics</b>						
$BV_{DSS}$	Drain to Source breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	650			V
$I_{DSs}$	Zero Gate Voltage Drain Current	$V_{DS}=650\text{V}, V_{GS}=0\text{V}, T_c=25^\circ\text{C}$			1	μA
$I_{GSS}$	Gate to Source Leakage Current	$V_{GS}=\pm 30\text{V}, V_{DS}=0\text{V}$			±100	nA



On state characteristics						
$V_{GS(th)}$	Gate to Source Threshold Voltage	$I_D=250\mu A, V_{GS}=V_{DS}$	2.0		4.0	V
$R_{DS(on)}$	Drain to Source On-Resistance	$I_D=3.5A, V_{GS}=10V$		1.13	1.6	$\Omega$
$G_{fs}$	Forward Transconductance	$V_{DS}=15V, I_D=3.5A$		8		S
Dynamic characteristics						
$C_{iss}$	Input Capacitance	$V_{DS}=25V, V_{GS}=0V, f=1MHz$		1200	1600	pF
$C_{oss}$	Output Capacitance			100	150	pF
$C_{rss}$	Reverse Transfer Capacitance			18	24	pF
Switching characteristics						
$t_{d(on)}$	Turn-On Delay Time	$V_{DD}=325V, I_D=7A$ $V_{GS}=10V, R_G=25\Omega$ (Note1,2)		35	80	ns
$t_r$	Rise Time			79	165	ns
$t_{d(off)}$	Turn-Off Delay Time			80	160	ns
$t_f$	Fall Time			52	120	ns
$Q_g$	Total Gate Charge	$V_{DD}=520V, I_D=7A$ $V_{GS}=10V$ (Note1,2)		30	—	nC
$Q_{gs}$	Gate to Emitter Charge			6.5	—	nC
$Q_{gd}$	Gate to Collector Charge			13	—	nC
Source Drain Diode Characteristics						
Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$I_s$	Maximum Continuous Drain-Source Diode Forward Current				7	A
$I_{SM}$	Maximum Pulsed Drain-Source Diode Forward Current				28	A
$V_{SD}$	Drain to Source Diode Forward Voltage	$I_S=7A, V_{GS}=0V$			1.4	V
$t_{rr}$	Diode Reverse Recovery Time	$I_S=7A, V_{GS}=0V$ $di/dt=100A/\mu S$		320		nS
$Q_{rr}$	Diode Reverse Recovery Charge			2.4		$\mu C$

Note:

1.Pulse Test:Pulse Width $\leq 300\mu s$ , Duty cycle $\leq 2\%$

2.Essentially Independent of operating Temperature Typical Characteristics

## Ratings and Characteristic Curves

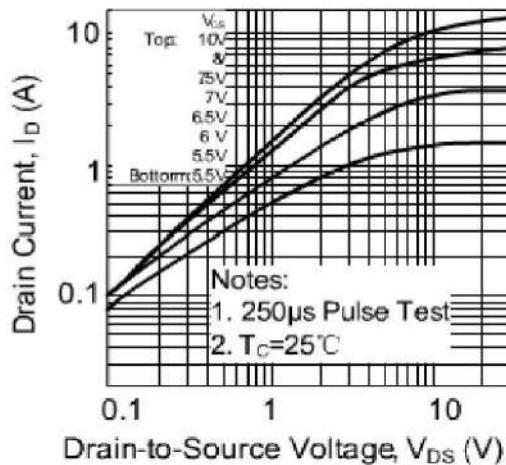


Fig.1 Output Characteristics

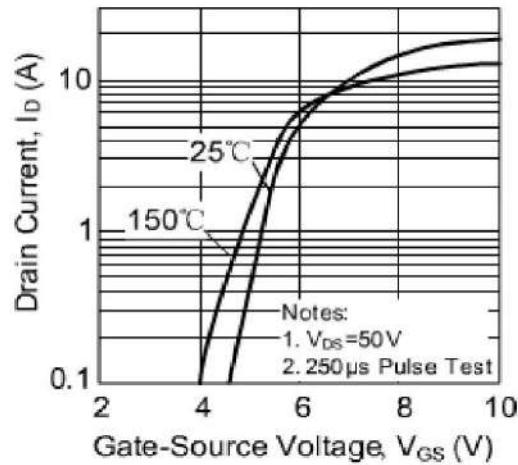


Fig.2 Transfer Characteristics

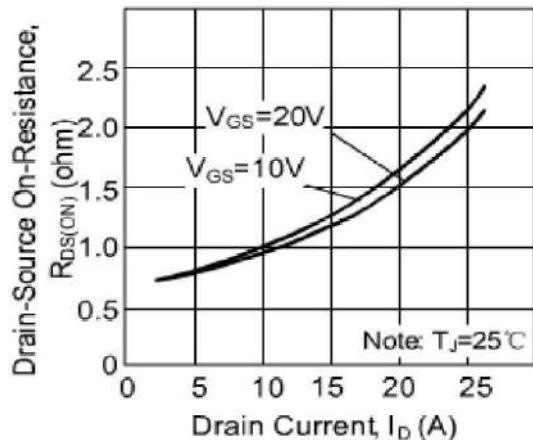


Fig.3 On-Resistance Variation vs. Drain Current and Gate Voltage

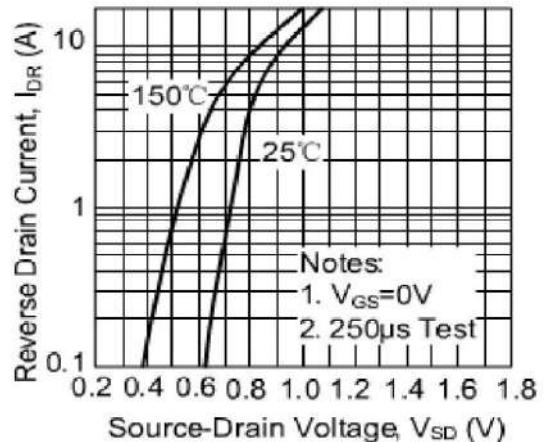


Fig.4 Body Diode Forward Voltage vs. Source Current and Temperature

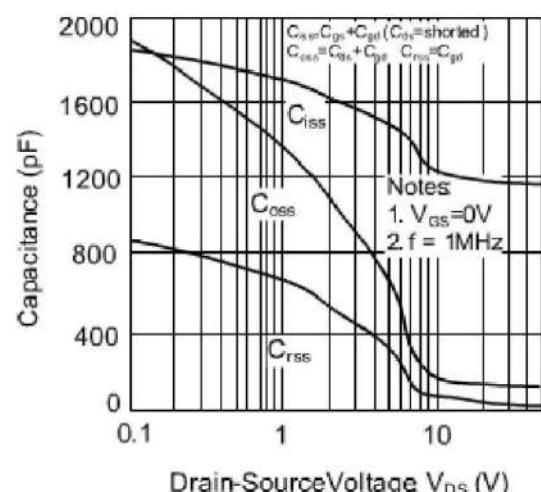


Fig.5 Capacitance Characteristics

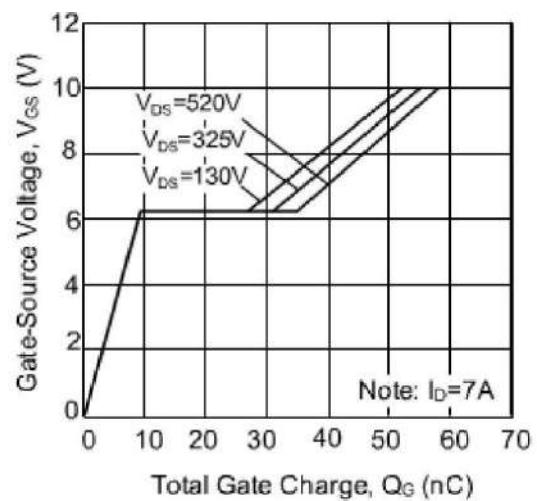
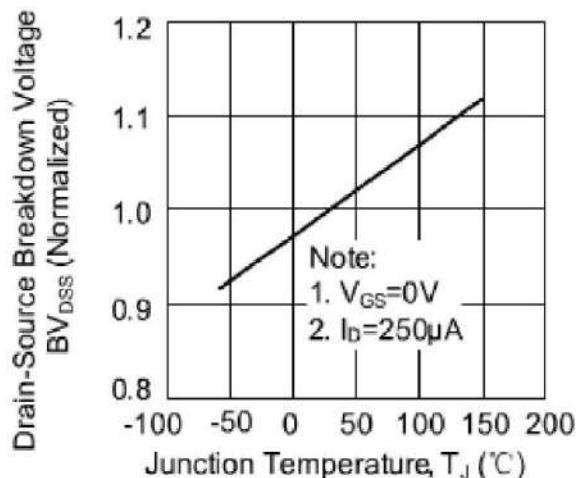
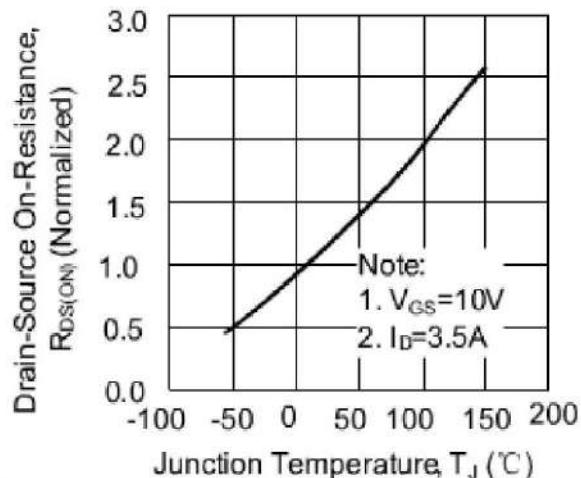


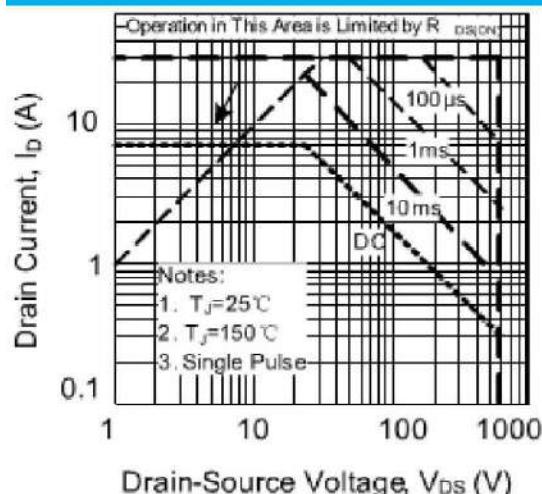
Fig.6 Gate Charge Characteristics



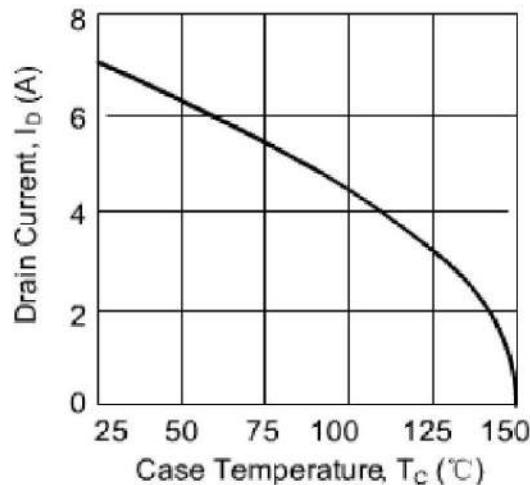
**Fig.7 Breakdown Voltage Variation vs. Temperature**



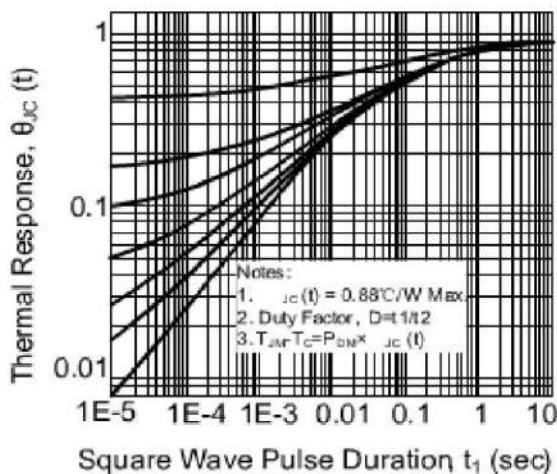
**Fig.8 On-Resistance Variation vs. Temperature**



**Fig.9 Maximum Safe Operating Area**

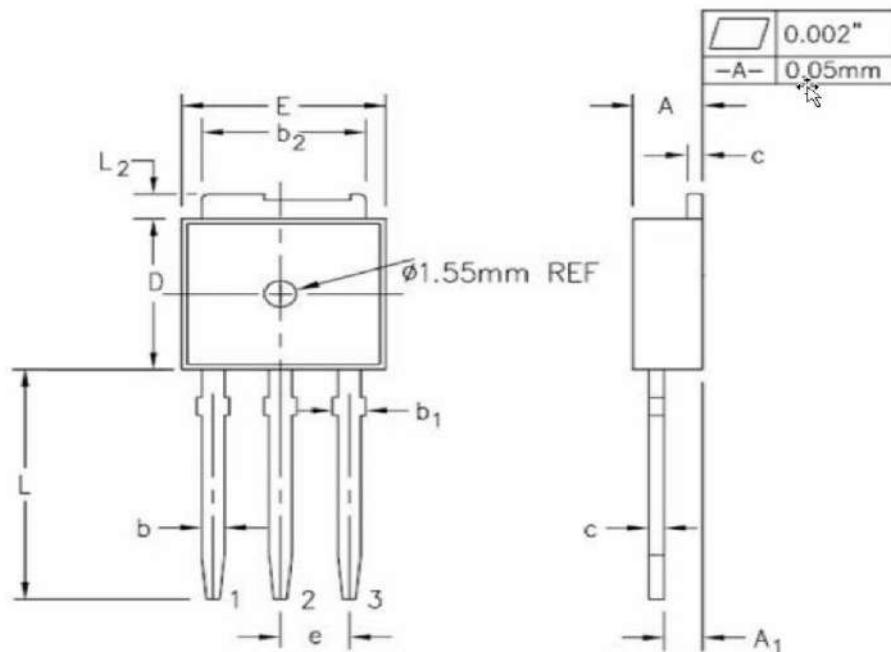


**Fig.10 Maximum Drain Current vs. Case Temperature**



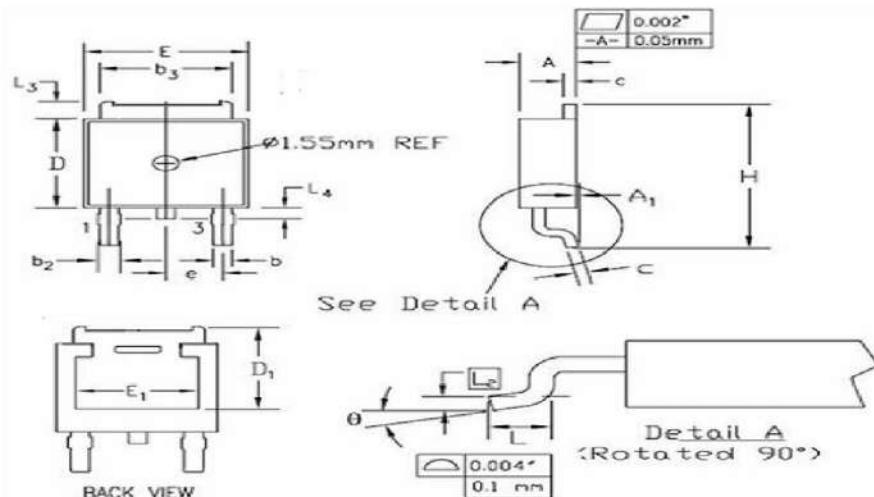
**Fig.11 Transient Thermal Response Curve**

## TO-251 POD



SYMBOL	INCHES		MILLIMETERS		NOTES
	MIN	MAX	MIN	MAX	
A	0.086	0.094	2.19	2.38	
A <sub>1</sub>	0.041	0.048	1.04	1.23	
b	0.025	0.035	0.64	0.89	
b <sub>1</sub>	0.027	0.039	0.69	0.92	
b <sub>2</sub>	0.206	0.216	5.23	5.48	
c	0.018	0.024	0.46	0.61	
D	0.241	0.249	6.12	6.32	
E	0.250	0.265	6.35	6.73	
e	0.090 TYP.		2.28 TYP.		
L	0.350	0.380	8.89	9.65	
L <sub>2</sub>	0.035	0.050	0.89	1.27	

## TO-252 POD



SYMBOL	INCHES		MILLIMETERS		NOTES
	MIN	MAX	MIN	MAX	
A	0.086	0.094	2.19	2.38	
A1	-	0.005	-	0.13	
b	0.025	0.035	0.64	0.89	
b2	0.033	0.045	0.84	1.14	
b3	0.205	0.215	5.21	5.46	
c	0.018	0.024	0.46	0.61	
D	0.241	0.249	6.12	6.32	
D1	0.205	-	5.21	-	
E	0.250	0.265	6.35	6.73	
E1	0.190	-	4.83	-	
e	0.090 BSC.		2.29 BSC.		
H	0.380	0.410	9.65	10.41	
L	0.055	0.070	1.40	1.78	
L2	0.020 BSC.		0.51 BSC.		
L3	0.035	0.050	0.89	1.27	
L4	0.025	0.040	0.64	1.01	
$\theta$	$0^\circ$	$8^\circ$	$0^\circ$	$8^\circ$	